



<b>Information Disclosure Citation in an Application</b>	Application No. <b>09/510,607</b>	Applicant(s) <b>Brian M. Kennedy</b>	
	Docket Number <b>020431.0662</b>	Group Art Unit <b>2166</b>	Filing Date <b>February 22, 2000</b>

**U.S. PATENT DOCUMENTS**

		<b>DOCUMENT NO.</b>	<b>DATE</b>	<b>NAME</b>	<b>CLASS</b>	<b>SUBCLASS</b>	<b>FILING DATE</b>
	<b>A</b>	4,992,940	02/12/1991	Dworkin	364	401	03/13/1989
	<b>B</b>	5,041,972	08/20/1991	Frost	364	401	04/15/1998
	<b>C</b>	5,237,496	08/17/1993	Kagami et al.	364	401	03/24/1992
	<b>D</b>	5,305,199	04/19/1994	LoBiondo et al.	364	403	10/28/1992
	<b>E</b>	5,321,833	06/14/1994	Chang et al.	395	600	08/29/1990
	<b>F</b>	5,570,291	10/29/1996	Dudle et al.	364	268.01	08/31/1994
	<b>G</b>	5,715,444	02/03/1998	Danish et al.	395	604	10/14/1994
	<b>H</b>	5,734,890	03/31/1998	Case et al	395	605	08/22/1995
	<b>I</b>	5,758,329	05/26/1998	Wojcik et al.	705	28	06/07/1995
	<b>J</b>	5,765,143	06/09/1998	Sheldon et al.	705	28	03/10/1995
	<b>K</b>	5,809,144	09/15/1998	Sirbu et al.	380	25	08/24/1995
	<b>L</b>	5,826,260	10/20/1998	Byrd Jr., et al.	707	5	12/11/1995
	<b>M</b>	5,873,076	02/16/1999	Barr et al.	707	3	08/15/1995
	<b>N</b>	5,918,213	06/29/1999	Bernard et al.	705	26	12/22/1995
	<b>O</b>	5,960,414	09/28/1999	Rand et al.	705	28	11/25/1997
	<b>P</b>	5,963,920	10/05/1999	Rose et al.	705	28	06/19/1997
	<b>Q</b>	5,995,947	11/30/1999	Fraser et al.	705	38	09/12/1997
	<b>R</b>	6,009,407	12/28/1999	Garg	705	10	02/27/1998
	<b>S</b>	6,012,051	01/04/2000	Sammon, Jr. et al.	706	52	02/06/1997
	<b>T</b>	6,049,777	04/11/2000	Sheena et al.	705	10	03/14/1997

**FOREIGN PATENT DOCUMENTS**

		<b>DOCUMENT NO.</b>	<b>DATE</b>	<b>COUNTRY</b>	<b>CLASS</b>	<b>SUBCLASS</b>	<b>TRANSLATION</b>
							<b>YES</b> <b>NO</b>

**NON-PATENT DOCUMENTS**

		<b>DOCUMENT (Including Author, Title, Source, and Pertinent Pages)</b>	<b>DATE</b>
<b>EXAMINER</b>		<b>DATE CONSIDERED</b>	

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP § 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the applicant.



Information Disclosure Citation in an Application			Application No. 09/510,607	Applicant(s) Brian M. Kennedy			
			Docket Number 020431.0662	Group Art Unit 2166	Filing Date February 22, 2000		
<b>U.S. PATENT DOCUMENTS</b>							
		DOCUMENT NO.	DATE	NAME	CLASS	SUBCLASS	FILING DATE
	<b>A</b>	6,064,980	05/16/2000	Jacobi et al.	705	26	03/17/1998
	<b>B</b>	6,167,380	12/26/2000	Kennedy et al.	705	10	02/18/1997
	<b>C</b>	6,195,652	02/27/2001	Fish	707	2	10/28/1999
	<b>D</b>	6,249,774	06/19/2001	Roden et al.	705	28	02/23/1999
	<b>E</b>	6,226,652	05/01/2001	Percival	707	203	09/05/1997
	<b>F</b>	6,321,133	11/20/2001	Smirnov et al.	700	100	12/04/1998
	<b>G</b>	6,324,522	11/27/2001	Peterson et al.	705	28	09/15/1998
	<b>H</b>	6,463,345	10/08/2002	Peachy-Kountz et al.	700	99	01/04/1999
	<b>I</b>	6,484,165	11/19/2002	Beall et al.	707	3	08/02/2001
	<b>J</b>	6,505,172	07/07/2003	Johnson et al.	705	27	03/22/2000
	<b>K</b>	6,519,648	02/11/2003	Eyal	709	231	06/11/2000
	<b>L</b>	6,567,820	05/20/2003	Scheifler et al.	707	103	11/21/2000
	<b>M</b>	6,601,043	07/29/2003	Purcell	705	26	06/26/2000
	<b>N</b>	2001/0047285	11/29/2001	Borders	705	8	03/16/2001
	<b>O</b>	2001/0044769	11/22/2001	Chavez	705	37	03/02/2001
	<b>P</b>	2002/0013721	01/31/2002	Dabbiere et al.	705	7	05/21/2001
	<b>Q</b>	2002/0019761	02/14/2002	Lidlow	705	10	01/11/2001
	<b>R</b>	2002/0049622	04/25/2002	Lettich et al.	705	7	04/26/2001
	<b>S</b>	2002/0029168	03/07/2002	McConnell Jr., et al.	705	26	01/02/2001
	<b>T</b>	2002/0082931	06/27/2002	Siegel et al.	705	26	12/21/2000
<b>FOREIGN PATENT DOCUMENTS</b>							
		DOCUMENT NO.	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION
							<b>YES</b> <b>NO</b>
<b>NON-PATENT DOCUMENTS</b>							
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		DOCUMENT NO.	DATE	NAME	CLASS	SUBCLASS	FILING DATE
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**FOREIGN PATENT DOCUMENTS**

		DOCUMENT NO.	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION
		A	WO 00/17795	03/30/2000	World Patent	G06F	17/60

**NON-PATENT DOCUMENTS**

	<b>DOCUMENT (Including Author, Title, Source, and Pertinent Pages)</b>	<b>DATE</b>
<b>B</b>	Allen, "Supply Chain Management Software, May 1998, University of Texas, Austin <a href="http://esallen.home.mindspring.com/erp.SCH.htm">http://esallen.home.mindspring.com/erp.SCH.htm</a>	05/1998
<b>C</b>	Available to Promise (ATP) <a href="http://sandbox.aiss.uiuc.edu/oracle/nca/mrp.atp.htm">http://sandbox.aiss.uiuc.edu/oracle/nca/mrp.atp.htm</a>	Unknown
<b>D</b>	carmax.com, webpages dated prior to 3/2/01 retrieved from archive.org, 10 pages	Unknown
<b>E</b>	Funaki, et al., "Method and System for Production Planning Transaction," JP02001331693A, EAST Version 1.03.0002, 58 pages	04/09/2002
<b>F</b>	Parker, "What New Tools will Best Save Time, Manufacturing Systems, Wheaton, Vol. 12, Issue 1, 6 Pages	November 1991
<b>G</b>	SAP Annual Report - 1998, SAP Ag. <a href="http://www.sap-ag.de/company/investor/reports/ar_onlin/1998/init_e.asp">http://www.sap-ag.de/company/investor/reports/ar_onlin/1998/init_e.asp</a>	1998
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